SPE for automotive and the transfer into industrial automation

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SPE for automotive and the transfer into industrial automation

Rosenberger

One of the worldwide leading manufacturers of standard and customer specific connectivity solutions.



Dr. Michael Wollitzer Head of R&D at Rosenberger



В

- Ethernet/IP-Networking is agnostic to PHY-layer
- Motivation for Single Pair Ethernet



Lessons learned in Automotive Applications



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Power over Datalines (PoDL) reduces Harness Complexity





Ethernet/IP-Networking is agnostic to PHY-layer A





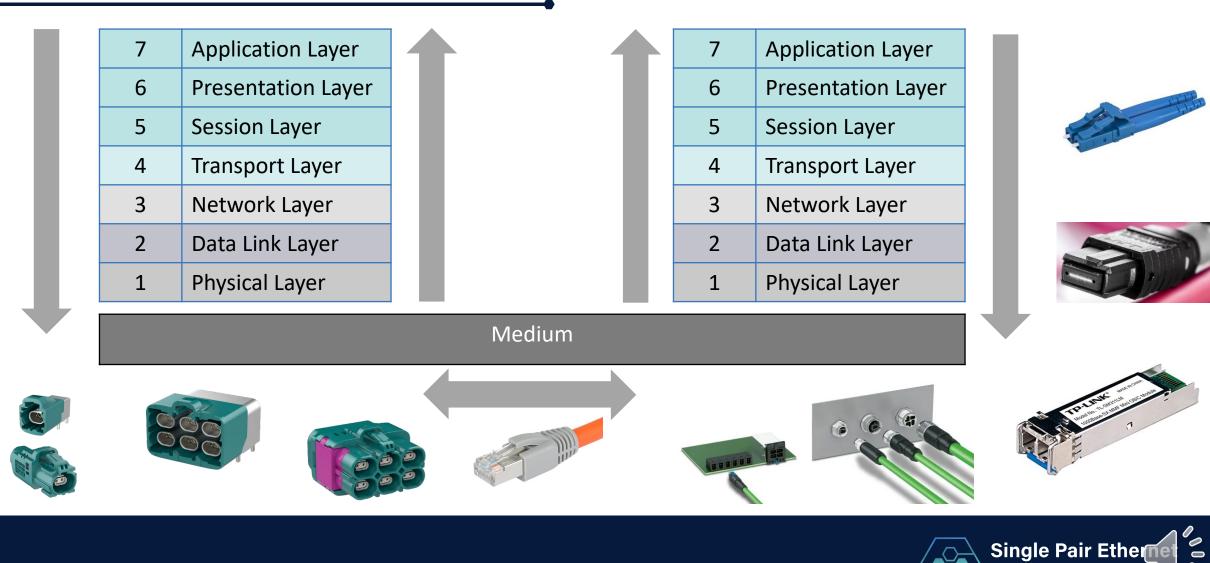
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Ethernet and the OSI-Layer-Model

Application Layers do not care about physical Implementation

OSI-Layer	"Ethernet"		
7 Application Layer	Application Layer		
6 Presentation Layer	(DNS, FTP, HTTP, NNTP, SMTP, SNMP, SSH, TELNET,)		
5 Session Layer			
4 Transport Layer	Transport-Layer (TCP/IP)		
3 Network Layer	Internet Laver (TCD/ID)	Media	
2 Data Link Layer	Logical Link Control (LLC), IEEE 802.2	Independent	
	Media Access Control (MAC), IEEE 802.1 5	Interface,	
1 Physical Layer	Reconciliation, IEEE 802.3	MII, GMII, …	
	Physical Coding Sublayer (PCS)	Media	Y
	Physical Medium Dependent (PMD)	Dependent	
		Interface,	
	Medium	CAT-Cable,	Single Pair Etherne
		SPE, Optics,	System Alliance

Ethernet and the OSI-Layer-Model



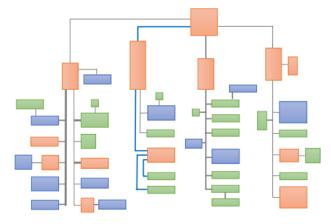




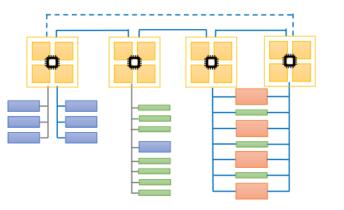
Trends in architecture

- Zone architecture
- Redundancy for autonomous driving
- Asymmetrical date rates

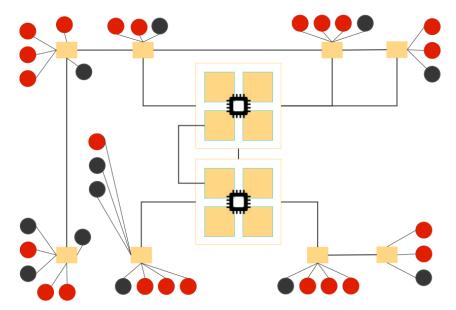
Traditional architecture



Domain architecture







Asymmetric Data Requirement

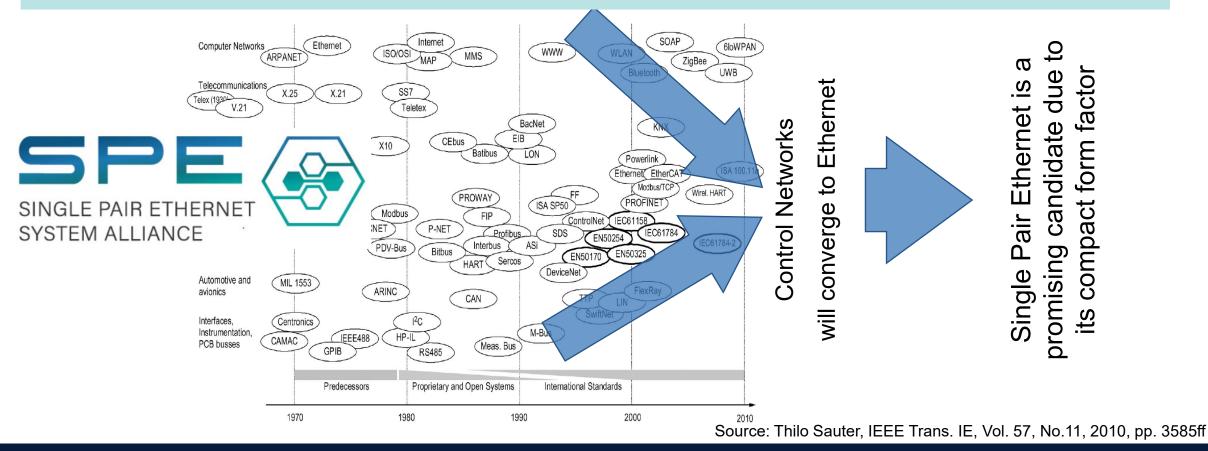


B Motivation for Single Pair Ethernet



Convergence to Single Pair Ethernet

The wild zoo of Standards for Networking of Devices will Converge to (Single Pair) Ethernet



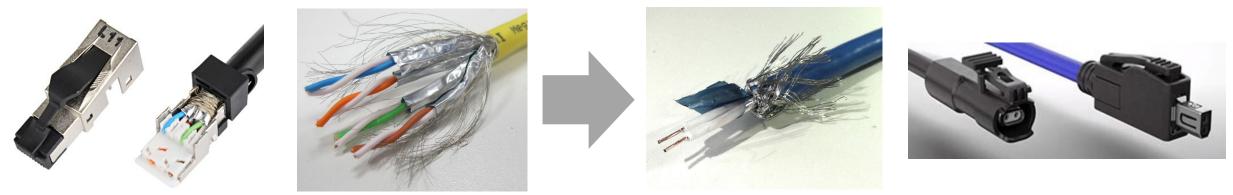


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Motivation for Single Pair Ethernet

Why Single Pair Ethernet?

- Current physical layer implementation: eight wire (four pair) CAT-cables
- Connectivity via RJ45 (eight terminals plus shield)



- Has drawbacks concerning complexity, weight, space consumption, field confectioning, physical flexibility, connector reliability, signal reliability
- Single Pair Ethernet is a means to improve electrical and mechanical properties of the PHY-layer (reliability, signalling performance, assembly automation ...)



Motivation for Single Pair Ethernet

Miniaturization

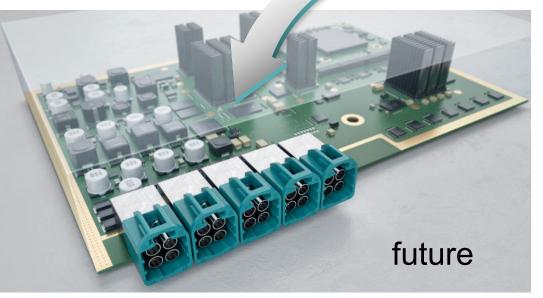
- Miniaturization of the connector's footprint on interconnect panels is desired in future applications
- Miniaturization leads to limitations on the physical dimensions of the cables
- Connectors get smaller but cables should be larger for low attenuation -> Compromise to be found



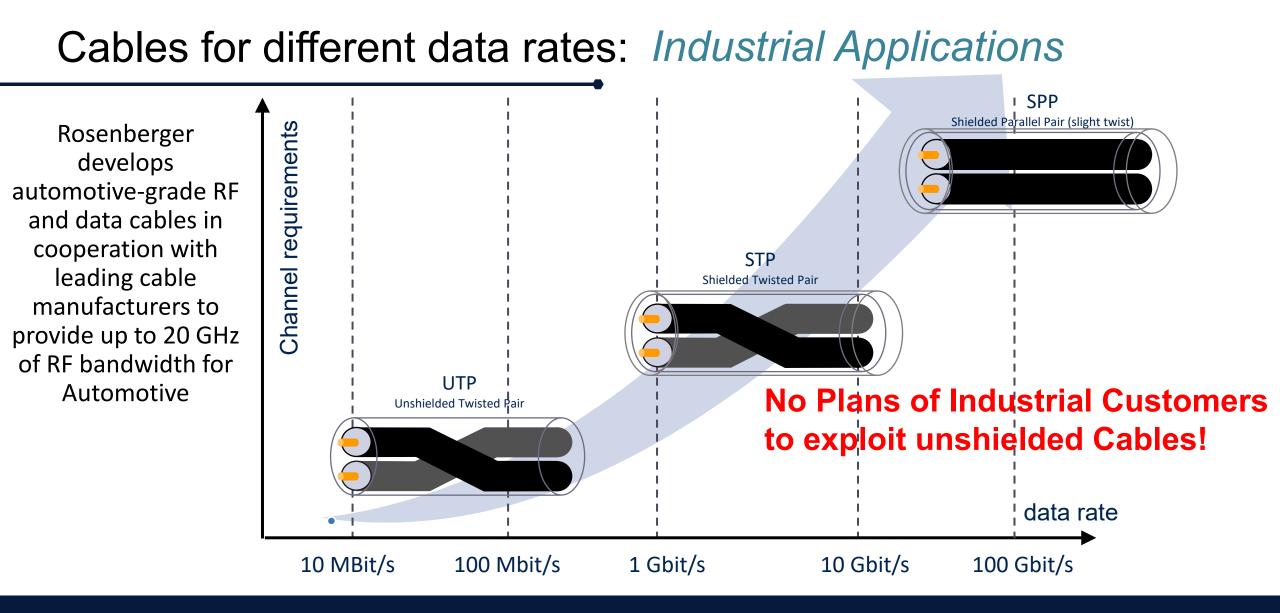


Cables should target diameter < 5 mm for differential links











Finalized IEEE-Standards for SPE

IEEE-Standard	Technical Comment
IEEE P802.3cg (10Base-T1); still in Draft Version	10 Mbit/s SPE, PAM-3?, 2.4V-Operation has 1000 m Reach, 1.0V-Operation has 15 m Reach
IEEE 802.3bw-2015 (100Base-T1); finalized	100 Mbit/s SPE, PAM-3, 4B/3B-coding Spec for reach up to 15 m is finalized; longer links to be specified in future releases; no physical reason, why 100 m-links should not work (consider propdelay-spec!)
IEEE 802.3bp-2016 (1000Base-T1); finalized	1000 Mbit/s SPE, PAM-3, 80B/81B-coding Spec is finalized; link segments type A (15 m, propagation delay < 94 ns) and type B (40 m, propagation delay < 234 ns) are specified 100 m-links not feasible with current technology;
IEEE 802.3bu-2016 (PoDL; Power over DataLines); finalized	Power over DataLines specified for 100Mbit/s- and 1000Mbit/s- Operation; Loop Resistance has to be very low depending on power class; power at device up to 50 W Additional ferrite components req'd



Estimation of Req'd Wire CrossSection

SPE-Datarate as specified in IEEE	Length	Spec'd Frequency max. spec'd IL	Conductor CrossSection / sqmm @ Tamb = 85°C	AWG	
10 Mbit/s	1000 m	20 MHz, 58.35 dB	0.792	18	
10 Mbit/s	500 m	20 MHz, 58.35 dB	0.201	24	
10 Mbit/s	100 m	20 MHz, 58.35 dB	0.0089	37	
100 Mbit/s	15 m	66 MHz, 7.2 dB	0.0425	30	
1000 Mbit/s	15 m	600 MHz, 15.88 dB	0.0904	27	
1000 Mbit/s	40 m	600 MHz, 22.27 dB	0.292	22	
1000 Mbit/s (not spec'd! Just for comparison!!)	100 m	600 MHz, 22.27 dB (40 m loss budget assumed. Propagation delay will not meet spec!)	1.69	14	

Assumptions: Validity of scaling models; dielectric losses negligible





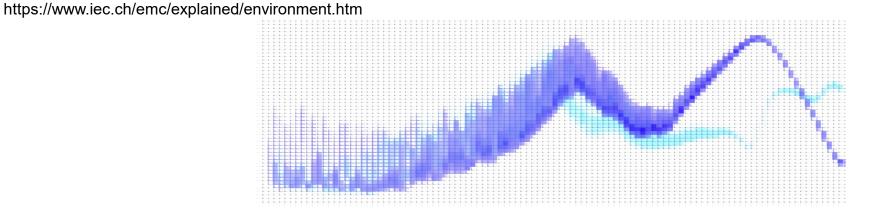




Why EMC takes a Major Role in the car

- EMC means: "the ability of equipment or a system to function satisfactorily in its electromagnetic environment without introducing intolerable electromagnetic disturbances to anything in that environment."
- "The aim of EMC is to ensure the reliability and safety of all types of systems wherever they are used and exposed to electromagnetic environments. So EMC development is closely linked with the whole field of electrical and electronic engineering, including the design and testing of these systems."

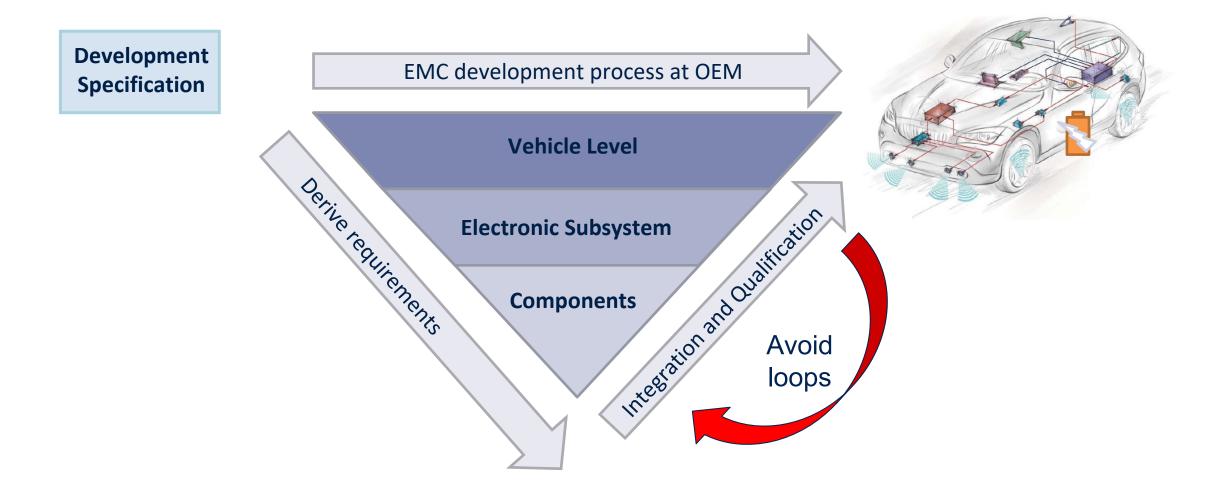
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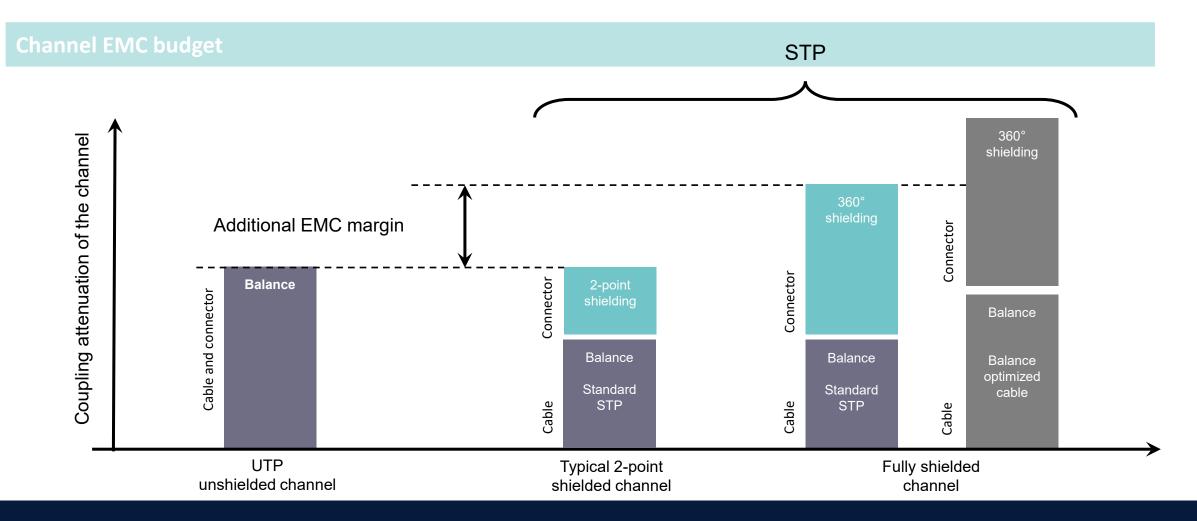


The V-Model in EMC-robust Design





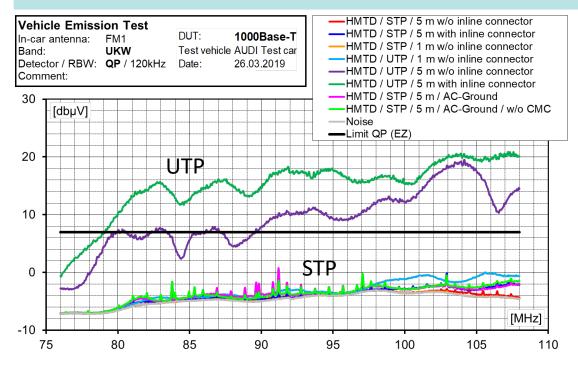
Automotive Ethernet Status of Implementation



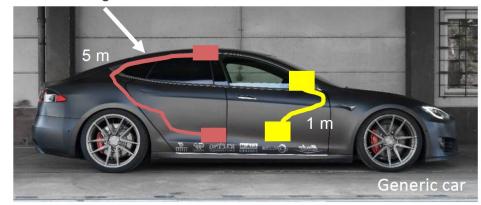


1000BASE-T1 Vehicle Measurement

Measurement results



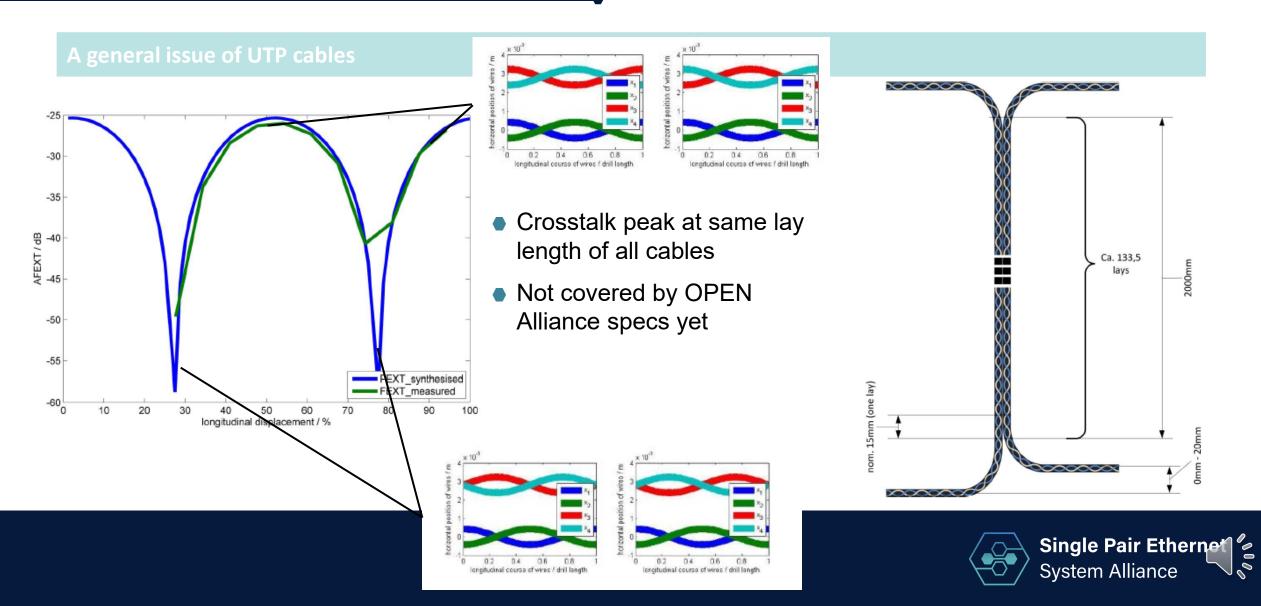




- H-MTD with UTP: 1 m link passes, 5 m link above the limit for emissions into antenna
- H-MTD with STP passes with margin (noise level)
- To implement UTP for 1000BASE-T1, the OEM should test EMC on vehicle level



Crosstalk in Bundles

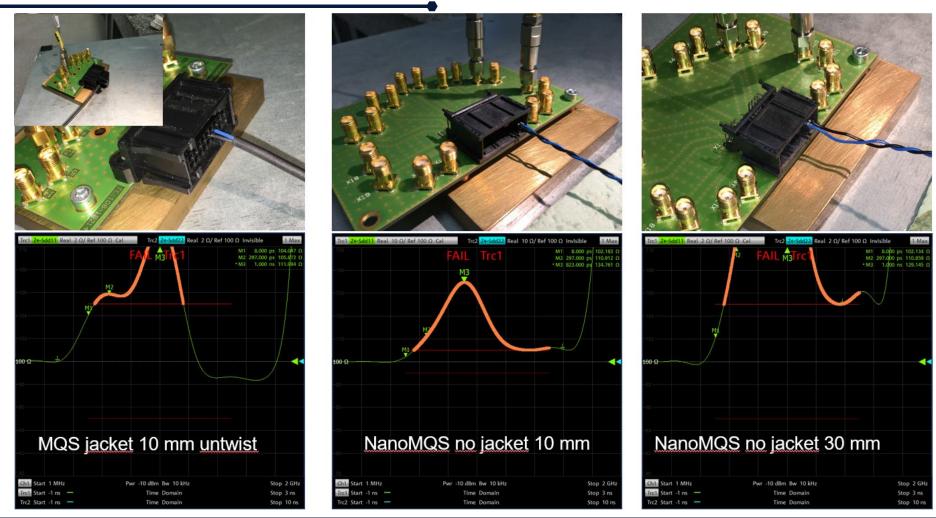


D Lessions learned in Automotive Applications



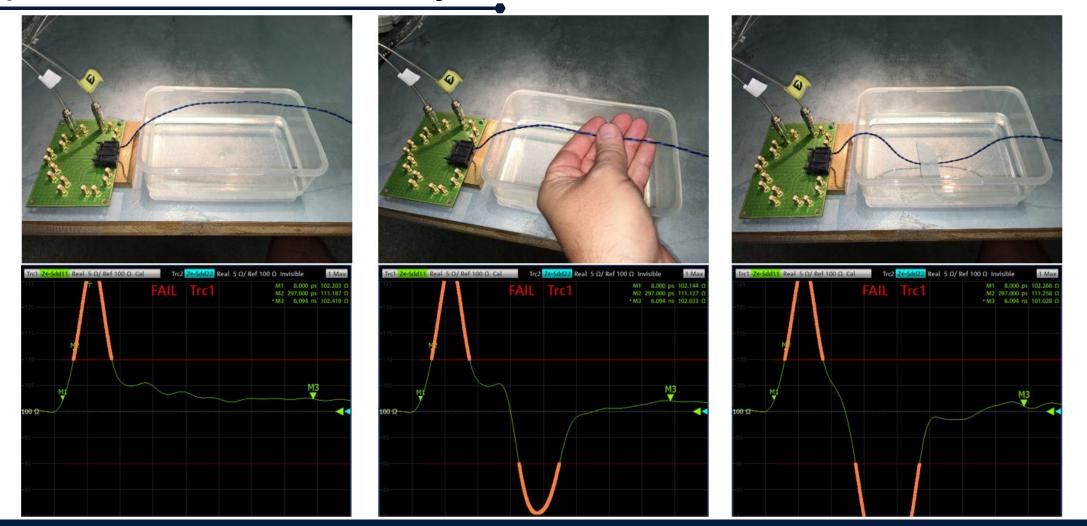


Untwist





Exposure to water – Non-jacketed UTP





Automotive Ethernet

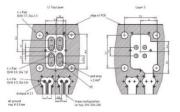
Design-In Support

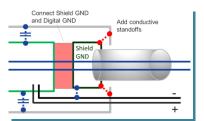
- Contribute in standardization
- Collaborate with PHY vendors
- Layout recommendations
- Signal path layout review
- EMC aspects of PCB grounding concepts
- Test adapters and break-out boards
- Measurement couplers for debugging in the car

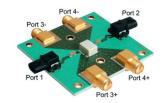














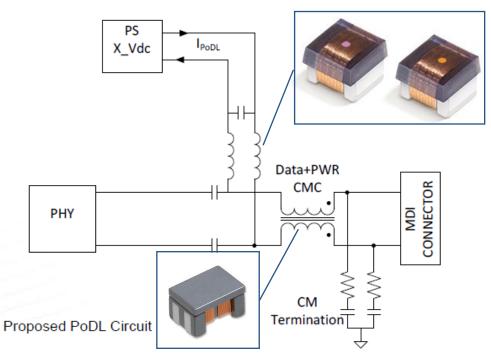


E Power over Datalines (PoDL) reduces Harness Complexity



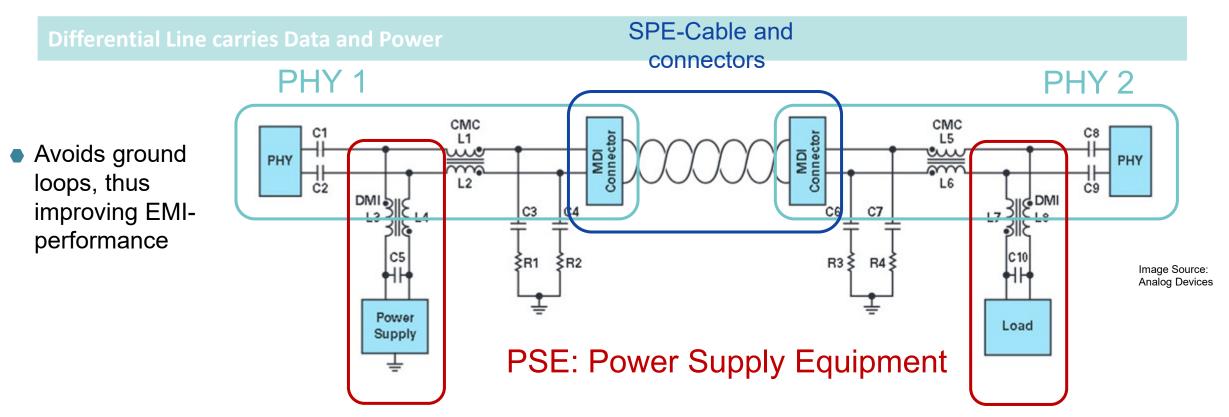
Power over Dataline (PoDL)

- Specified for SPE in IEEE 802.3bu
- Transmission of DC-power on a signal pair on top of the datastream is more difficult than if shield is used as DC-return (forward- reverse current act like a differential signal)
- Current rating is limited by the inductor's properties
 - RF-properties (physical size of the ferrite components!)
 - Symmetry
 - Wire dimensions
 - Ferrite core material (saturation effects!)
- DC resistance of the signal wires and thus voltage drop on the cable limit the possible cable length





Power over DataLines (PoDL); IEEE 802.3bu-2016



Transmission of data and energy on one cable;

no additional power cable is required! No inductive coupling loops!



Power over DataLines (PoDL)

System Class									
R_{Loop} loss	I	I	II	Ш	III	III	IV	V	VI
20%	(5V)	(12V)	(12V)	(24V)	(24V)	(48V)	(48V)	(48V)	(Open)
*V _{PSE(max)} (V)	5.5	14	14	28	28	56	56	56	-
*V _{PSE(min)} (V)	4.75	9	9	18	18	36	36	36	-
I _{PI(max)} (A)	0.53	0.28	0.69	0.35	0.69	0.35	0.87	2.08	-
** $R_{Loop(max)}\left(\Omega\right)$	1.8	6.5	2.6	10.4	5.2	20.7	8.3	3.5	-
***P _{PD(max)} (W)	2	2	5	5	10	10	25	60	-
P _{PSE} (W)	2.5	2.5	6.25	6.25	12.5	12.5	31.25	75	-
V _{PD(min)}	3.8	7.2	7.2	14.4	14.4	28.8	28.8	28.8	-

 $^*V_{\mathsf{PSE}}$ is the open circuit voltage measured at the PSE PI. $^{**}\mathsf{R}_{\mathsf{Loop}}$ is defined as the sum of the PSE source resistance and link segment round trip resistance.

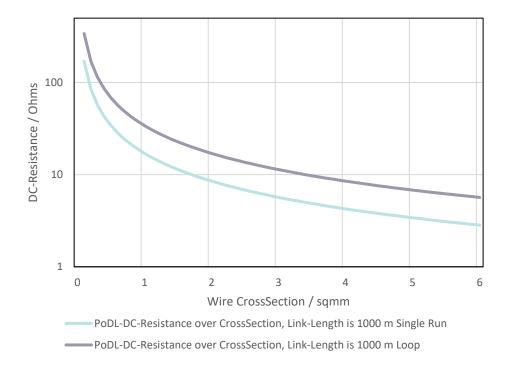
***P_{PD} is measured at the PD PI.



Power over DataLines (PoDL): 10Base-T1 over 1000 m

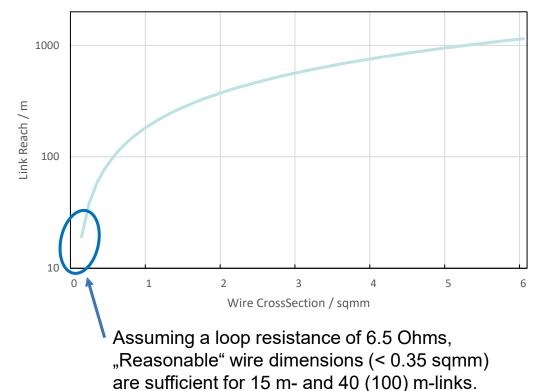
Reach according to IEEE-Specs at Room Temperature; Assessment based on Loop Resistance

Link Resistance over Wire-CrossSection



Cable dimensions get unrealistically large for 1000 m-links!

Link Reach over Wire-CrossSection





Thank You



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